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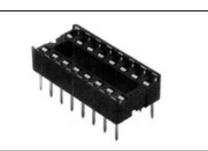
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Home > Products > By Type > Socket/Card Products > Product Feature Selector > Product Details

390263-2 Product Details

Documentation



390263-2

TE Internal Number: 390263-2

DIP Sockets

Resources

Not EU RoHS or ELV Compliant (Find RoHS Compliant Alternates)

Product Highlights:

- DIP Socket
- 32 Positions
- Row-to-Row Spacing = 15.24 mm
- Through Hole Contact Termination Type
- Mount Style = Vertical

View all Features

Search for Replacement Parts

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Documentation & Additional Information

Product Drawings:

DIP SOCKET, 15.24 CENTERLINE OTC STYLE (PDF, English)

Catalog Pages/Data Sheets:

None Available

Product Specifications:

None Available

Application Specifications:

None Available

Instruction Sheets:

None Available

CAD Files:

None Available

Additional Information:

Product Line Information

Buy Product

Related Products:

Tooling

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Product Type = DIP Socket
- Number of Positions = 32
- Profile = Over-The-Component
- Frame Style = Open
- <u>Leq Style</u> = Straight
- Color = Black

Electrical Characteristics:

- Insulation Resistance (MΩ) = 10,000
- Contact Resistance (mΩ) = 30

Termination Related Features:

Termination Post Length (mm [in]) = 3.00 [0.118]

Body Related Features:

- Row-to-Row Spacing (mm [in]) = 15.24 [0.600]
- Mount Style = Vertical
- Centerline (mm [in]) = 2.54 [0.100]

Contact Related Features:

- Contact Termination Type = Through Hole
- Contact Base Material = Phosphor Bronze
- Contact Plating, Mating Area, Material = Tin-Lead
- Contact Style = Stamped + Formed
- Mating Contact Type = Dual Leaf

Housing Related Features:

Housing Material = Thermoplastic

Configuration Related Features:

Height Above PC Board (mm [in]) = 5.10 [0.200]

Industry Standards:

List all Documents

- RoHS/ELV Compliance = Not ELV/RoHS compliant
- <u>Lead Free Solder Processes</u> = Wave solder capable to 240°C, Wave solder capable to 260°C, Wave solder capable to 265°C

Conditions for Usage:

Temperature Range (°C) = -40 - +105

Packaging Related Features:

Packaging Method = Tube

Other:

Brand = AMP

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